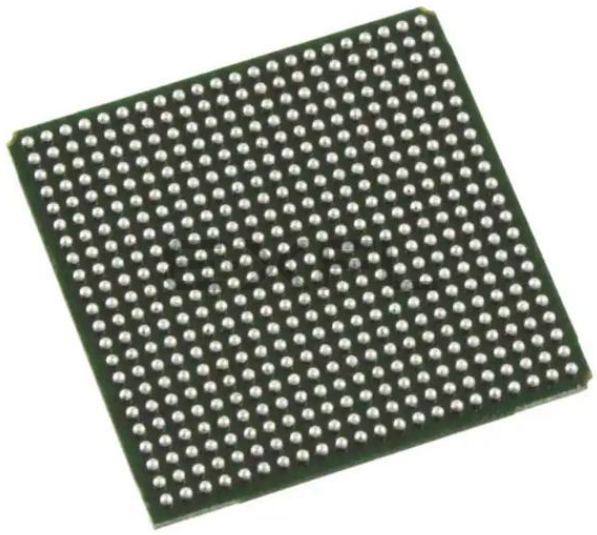
Lattice Semiconductor Corporation - LFE2-12SE-7F484C Datasheet



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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	1500
Number of Logic Elements/Cells	12000
Total RAM Bits	226304
Number of I/O	297
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-12se-7f484c

ROM Mode
ROM mode uses the LUT logic; hence, Slices 0 through 3 can be used in ROM mode. Preloading is accomplished through the programming interface during PFU configuration.

Routing

There are many resources provided in the LatticeECP2/M devices to route signals individually or as buses with related control signals. The routing resources consist of switching circuitry, buffers and metal interconnect (routing) segments.

The inter-PFU connections are made with x1 (spans two PFU), x2 (spans three PFU) and x6 (spans seven PFU). The x1 and x2 connections provide fast and efficient connections in horizontal and vertical directions. The x2 and x6 resources are buffered, allowing the routing of both short and long connections between PFUs.

The LatticeECP2/M family has an enhanced routing architecture that produces a compact design. The Diamond design software takes the output of the synthesis tool and places and routes the design. Generally, the place and route tool is completely automatic, although an interactive routing editor is available to optimize the design.

sysCLOCK Phase Locked Loops (GPLL/SPLL)

The sysCLOCK PLLs provide the ability to synthesize clock frequencies. All the devices in the LatticeECP2/M family support two General Purpose PLLs (GPLLs) which are full-featured PLLs. In addition, some of the larger devices have two to six Standard PLLs (SPLLs) that have a subset of GPLL functionality.

General Purpose PLL (GPLL)

The architecture of the GPLL is shown in Figure 2-5. A description of the GPLL functionality follows.

CLKI is the reference frequency (generated either from the pin or from routing) for the PLL. CLKI feeds into the Input Clock Divider block. The CLKFB is the feedback signal (generated from CLKOP or from a user clock PIN/logic). This signal feeds into the Feedback Divider. The Feedback Divider is used to multiply the reference frequency.

The Delay Adjust Block adjusts either the delays of the reference or feedback signals. The Delay Adjust Block can either be programmed during configuration or can be adjusted dynamically. The setup, hold or clock-to-out times of the device can be improved by programming a delay in the feedback or input path of the PLL, which will advance or delay the output clock with reference to the input clock.

Following the Delay Adjust Block, both the input path and feedback signals enter the Voltage Controlled Oscillator (VCO) block. In this block the difference between the input path and feedback signals is used to control the frequency and phase of the oscillator. A LOCK signal is generated by the VCO to indicate that the VCO has locked onto the input clock signal. In dynamic mode, the PLL may lose lock after a dynamic delay adjustment and not relock until the t_{LOCK} parameter has been satisfied. LatticeECP2/M devices have two dedicated pins on the left and right edges of the device for connecting optional external capacitors to the VCO. This allows the PLLs to operate at a lower frequency. This is a shared resource that can only be used by one PLL (GPLL or SPLL) per side.

The output of the VCO then enters the post-scalar divider. The post-scalar divider allows the VCO to operate at higher frequencies than the clock output (CLKOP), thereby increasing the frequency range. A secondary divider takes the CLKOP signal and uses it to derive lower frequency outputs (CLKOK). The Phase/Duty Select block adjusts the phase and duty cycle of the CLKOP signal and generates the CLKOS signal. The phase/duty cycle setting can be pre-programmed or dynamically adjusted.

The primary output from the post scalar divider CLKOP along with the outputs from the secondary divider (CLKOK) and Phase/Duty select (CLKOS) are fed to the clock distribution network.

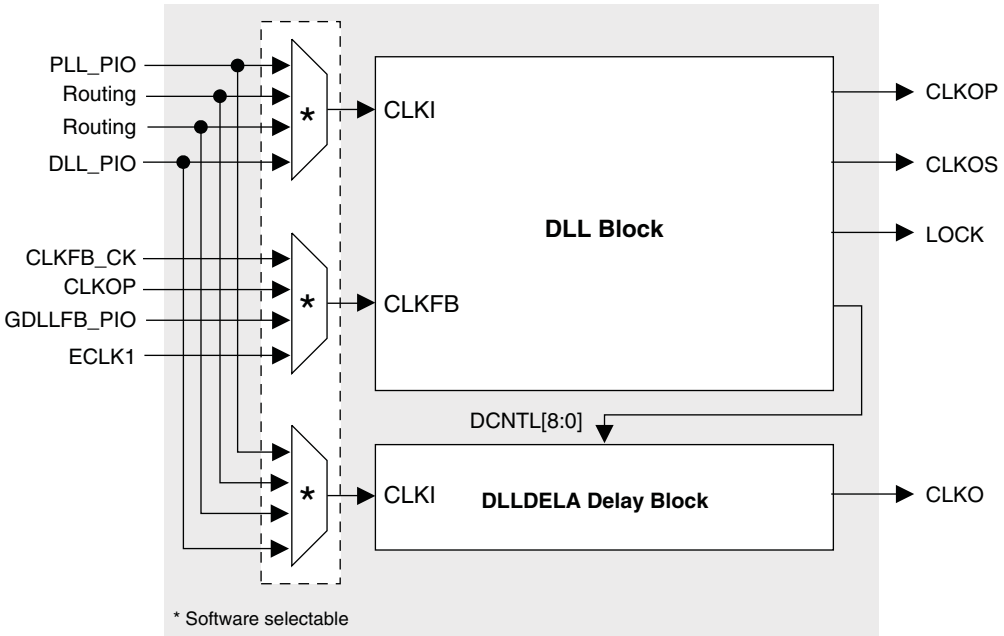
Table 2-5. DLL Signals

Signal	I/O	Description
CLKI	I	Clock input from external pin or routing
CLKFB	I	DLL feed input from DLL output, clock net, routing or external pin
RSTN	I	Active low synchronous reset
ALUHOLD	I	Active high freezes the ALU
UDDCNTL	I	Synchronous enable signal (hold high for two cycles) from routing
DCNTL[8:0]	O	Encoded digital control signals for PIC INDEL and slave delay calibration
CLKOP	O	The primary clock output
CLKOS	O	The secondary clock output with fine phase shift and/or division by 2 or by 4
LOCK	O	Active high phase lock indicator

DLLDELA Delay Block

Closely associated with each DLL is a DLLDELA block. This is a delay block consisting of a delay line with taps and a selection scheme that selects one of the taps. The DCNTL[8:0] bus controls the delay of the CLKO signal. Typically this is the delay setting that the DLL uses to achieve phase alignment. This results in the delay providing a calibrated 90° phase shift that is useful in centering a clock in the middle of a data cycle for source synchronous data. The CLKO signal feeds the edge clock network. Figure 2-7 shows the connections between the DLL block and the DLLDELA delay block. For more information, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-7. DLLDELA Delay Block



PLL/DLL Cascading

LatticeECP2/M devices have been designed to allow certain combinations of PLL (GPLL and SPLL) and DLL cascading. The allowable combinations are:

- PLL to PLL supported
- PLL to DLL supported

for checking soft errors (SED) in SRAM. SED can be run on a programmed device when the user logic is not active. If a soft error occurs, during user mode (normal operation) the device can be programmed to either reload from a known good boot image or generate an error signal.

For further information about Soft Error Detect (SED) support, please see the list of additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP2/M devices require a single external, 10K ohm ±1% value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

On-Chip Oscillator

Every LatticeECP2/M device has an internal CMOS oscillator which is used to derive a Master Clock for configuration. The oscillator and the Master Clock run continuously and are available to user logic after configuration is completed. The software default value of the Master Clock is 2.5MHz. Table 2-16 lists all the available Master Configuration Clock frequencies for normal non-encrypted mode and encrypted mode. When a different Master Clock is selected during the design process, the following sequence takes place:

1. Device powers up with a Master Clock frequency of 3.1MHz.
2. During configuration, users select a different master clock frequency.
3. The Master Clock frequency changes to the selected frequency once the clock configuration bits are received.
4. If the user does not select a master clock frequency, then the configuration bitstream defaults to the Master Clock frequency of 2.5MHz.

This internal CMOS oscillator is available to the user by routing it as an input clock to the clock tree. For further information about the use of this oscillator for configuration or user mode, please see the list of additional technical documentation at the end of this data sheet.

Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration

Non-Encrypted Mode CCLK (MHz)			Encrypted Mode CCLK (MHz)
2.5[1]	13.0	45.0	2.5[1]
4.3	15.0	55.0	5.4
5.4	20.0	60.0	10.0
6.9	26.0	—	—
8.1	30.0	—	—
9.2	34.0	—	—
10.0	41.0	130.0	—

1. Software default frequency.

Density Shifting

The LatticeECP2/M family is designed to ensure that different density devices in the same family and in the same package have the same pinout. Furthermore, the architecture ensures a high success rate when performing design migration from lower density devices to higher density devices. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likelihood of success in each case. Design migration between LatticeECP2 and LatticeECP2M families is not possible. For specific requirements relating to sysCONFIG pins of the ECP2M50, M70 and M100, see the Logic Signal Connections tables.

LatticeECP2/M External Switching Characteristics[9] (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{DQVBS}	Data Valid Before DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
t_{DQVAS}	Data Valid After DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
f_{MAX_DDR2}	DDR Clock Frequency	ECP2/M	133	266	133	200	133	166	MHz
SPI4.2 I/O Pin Parameters Static Alignment[4, 8, 11]									
	Maximum Data Rate	ECP2-20	—	750	—	622	—	622	Mbps
		ECP2-35	—	750	—	622	—	622	Mbps
		ECP2-50	—	750	—	622	—	622	Mbps
		ECP2-70	—	750	—	622	—	622	Mbps
		ECP2M20	—	622	—	622	—	622	Mbps
		ECP2M35	—	622	—	622	—	622	Mbps
		ECP2M50	—	622	—	622	—	622	Mbps
		ECP2M70	—	622	—	622	—	622	Mbps
		ECP2M100	—	622	—	622	—	622	Mbps
$t_{DVACLKSPI}$	Data Valid After CLK (Receive)	ECP2-20	—	0.25	—	0.25	—	0.25	UI
		ECP2-35	—	0.25	—	0.25	—	0.25	UI
		ECP2-50	—	0.25	—	0.25	—	0.25	UI
		ECP2-70	—	0.25	—	0.25	—	0.25	UI
		ECP2M20	—	0.21	—	0.21	—	0.21	UI
		ECP2M35	—	0.21	—	0.21	—	0.21	UI
		ECP2M50	—	0.21	—	0.21	—	0.21	UI
		ECP2M70	—	0.21	—	0.21	—	0.21	UI
		ECP2M100	—	0.21	—	0.21	—	0.21	UI
$t_{DVECLKSPI}$	Data Hold After CLK (Receive)	ECP2-20	0.75	—	0.75	—	0.75	—	UI
		ECP2-35	0.75	—	0.75	—	0.75	—	UI
		ECP2-50	0.75	—	0.75	—	0.75	—	UI
		ECP2-70	0.75	—	0.75	—	0.75	—	UI
		ECP2M20	0.79	—	0.79	—	0.79	—	UI
		ECP2M35	0.79	—	0.79	—	0.79	—	UI
		ECP2M50	0.79	—	0.79	—	0.79	—	UI
		ECP2M70	0.79	—	0.79	—	0.79	—	UI
		ECP2M100	0.79	—	0.79	—	0.79	—	UI
t_{DIASPI}	Data Invalid After Clock (Transmit)	ECP2-20	—	280	—	280	—	280	ps
		ECP2-35	—	280	—	280	—	280	ps
		ECP2-50	—	280	—	280	—	280	ps
		ECP2-70	—	280	—	280	—	280	ps
		ECP2M20	—	230	—	230	—	230	ps
		ECP2M35	—	230	—	230	—	230	ps
		ECP2M50	—	230	—	230	—	230	ps
		ECP2M70	—	230	—	230	—	230	ps
		ECP2M100	—	230	—	230	—	230	ps

SERDES High-Speed Data Transmitter (LatticeECP2M Family Only)[1, 2]

Table 3-7. Serial Output Timing and Levels

Symbol	Description	Frequency	Min.	Typ.	Max.	Units
$V_{TX-DIFF-P-P-1}$	Differential swing (1V setting)[1, 2]	0.25 to 3.125 Gbps	0.79	0.99	1.19	V, p-p
$V_{TX-DIFF-P-P-1.25}$	Differential swing (1.25V setting)[1, 2]	0.25 to 3.125 Gbps	1.00	1.25	1.50	V, p-p
$V_{TX-DIFF-P-P-1.3}$	Differential swing (1.3V setting)[1, 2]	0.25 to 3.125 Gbps	1.04	1.30	1.56	V, p-p
$V_{TX-DIFF-P-P-1.35}$	Differential swing (1.35V setting)[1, 2]	0.25 to 3.125 Gbps	1.08	1.35	1.62	V, p-p
V_{OCM}	Output common mode voltage	—	V_{CCOB} - 0.75	V_{CCOB} - 0.60	V_{CCOB} - 0.45	V
T_{TX-R}	Rise time (20% to 80%)	—	—	70	—	ps
T_{TX-F}	Fall time (80% to 20%)	—	—	70	—	ps
$Z_{TX-OI-SE}$	Output impedance 50/75/HiZ K Ohms (single-ended)	—	—	50/70 HiZ	—	Ohms
R_{TX-RL}	Return loss (with package)	—	—	9	—	dB

1. All measurements are with 50 ohm impedance.
2. See TN1124, LatticeECP2M SERDES/PCS Usage Guide for actual binary settings.

Table 3-8. Channel Output Jitter - x10 Mode

Description	Frequency	Min.	Typ.	Max.	Units
Deterministic	3.125 Gbps	—	0.08	0.12	UI, p-p
Random	3.125 Gbps	—	0.22	0.38	UI, p-p
Total	3.125 Gbps	—	0.33	0.43	UI, p-p
Deterministic	2.5 Gbps	—	0.08	0.17	UI, p-p
Random	2.5 Gbps	—	0.20	0.25	UI, p-p
Total	2.5 Gbps	—	0.25	0.35	UI, p-p
Deterministic	1.25 Gbps	—	0.03	0.10	UI, p-p
Random	1.25 Gbps	—	0.14	0.19	UI, p-p
Total	1.25 Gbps	—	0.17	0.24	UI, p-p
Deterministic	250 Mbps	—	0.04	0.17	UI, p-p
Random	250 Mbps	—	0.12	0.13	UI, p-p
Total	250 Mbps	—	0.15	0.29	UI, p-p

Note: Values are measured with PRBS 2^7-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, reference clock at x10 mode.

LatticeECP2/M sysCONFIG Port Timing Specifications (Continued)

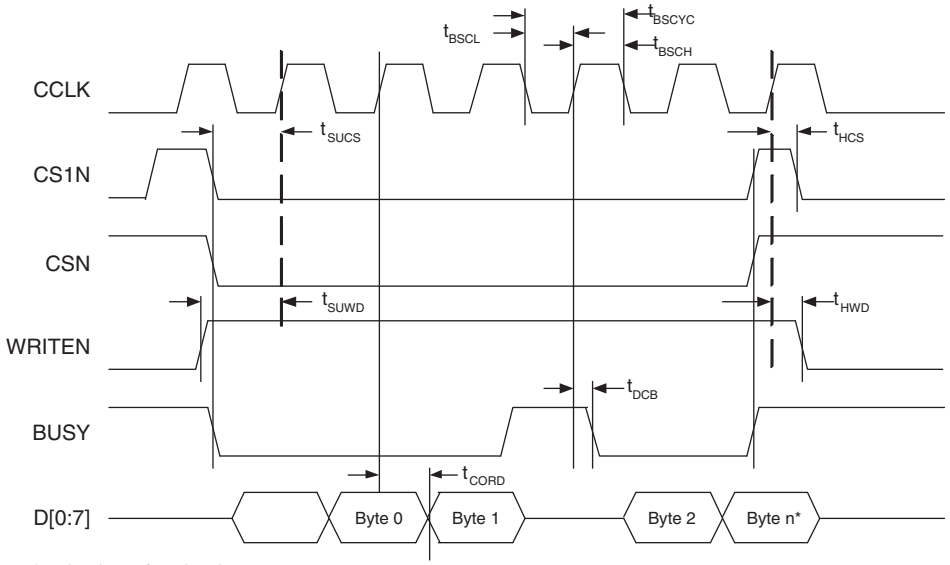
Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
f_{MAXSPI}	Max. CCLK Frequency - SPI Flash Read Opcode (0x03) (SPIFASTN = 1)	—	20	MHz
	Max. CCLK Frequency - SPI Flash Fast Read Opcode (0x0B) (SPIFASTN = 0)	—	50	MHz
	Max. CCLK Frequency - Encrypted Bitstream	—	10	MHz
t_{SUSPI}	SOSPI Data Setup Time Before CCLK	7	—	ns
t_{HSPI}	SOSPI Data Hold Time After CCLK	2	—	ns
t_{SUMCDI}	DI Setup to CCLK	7	—	ns
t_{HMCDI}	DI Hold from CCLK	1	—	ns

1. Re-toggling the PROGRAMN pin is not permitted until the INITN pin is high. Avoid consecutive toggling of the PROGRAMN.
2. For SED (Soft Error Detect), the SEDCLKIN operating frequency must be at least 20MHz. SEDCLKIN is derived from Master Clock Frequency that has a +/-30% variation..

Parameter	Min.	Max.	Units
Master Clock Frequency	Selected value - 30%	Selected value + 30%	MHz
Duty Cycle	40	60	%

Figure 3-14. sysCONFIG Parallel Port Read Cycle



*n = last byte of read cycle.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
136	PT6B	0		C	PT16B	0		C
137	PT6A	0		T	PT16A	0		T
138	GND	-			GND	-		
139	VCCIO0	0			VCCIO0	0		
140	PT4B	0		C	PT6B	0		C
141	PT4A	0		T	PT6A	0		T
142	VCCAUX	-			VCCAUX	-		
143	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C
144	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one-to-one connection with a package ball or pin.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
46	PL28B	6	LDQ28	C (LVDS)*	PL42B	6	LDQ42	C (LVDS)*
47	PL30A	6	LDQ28		PL44A	6	LDQ42	
48	TCK	-			TCK	-		
49	TDI	-			TDI	-		
50	TDO	-			TDO	-		
51	VCCJ	-			VCCJ	-		
52	TMS	-			TMS	-		
53	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
54	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
55	VCCIO5	5			VCCIO5	5		
56	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T
57	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C
58	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T
59	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C
60	GND	-			GND	-		
61	PB12A	5	BDQ15	T	PB12A	5	BDQ15	T
62	PB12B	5	BDQ15	C	PB12B	5	BDQ15	C
63	VCCIO5	5			VCCIO5	5		
64	PB16A	5	BDQ15	T	PB16A	5	BDQ15	T
65	PB16B	5	BDQ15	C	PB16B	5	BDQ15	C
66	PB18A	5	BDQ15	T	PB18A	5	BDQ15	T
67	PB18B	5	BDQ15	C	PB18B	5	BDQ15	C
68	GND	-			GND	-		
69	PB20A	5	BDQ24	T	PB30A	5	BDQ33	T
70	VCCAUX	-			VCCAUX	-		
71	PB20B	5	BDQ24	C	PB30B	5	BDQ33	C
72	PB22A	5	BDQ24	T	PB32A	5	BDQ33	T
73	PB22B	5	BDQ24	C	PB32B	5	BDQ33	C
74	VCC	-			VCC	-		
75	PB26A	5	PCLKT5_0/BDQ24	T	PB35A	5	PCLKT5_0/BDQ33	T
76	PB26B	5	PCLKC5_0/BDQ24	C	PB35B	5	PCLKC5_0/BDQ33	C
77	GND	-			GND	-		
78	PB31A	4	PCLKT4_0/BDQ33	T	PB40A	4	PCLKT4_0/BDQ42	T
79	PB31B	4	PCLKC4_0/BDQ33	C	PB40B	4	PCLKC4_0/BDQ42	C
80	VCC	-			VCC	-		
81	GND	-			GND	-		
82	PB34A	4	BDQ33	T	PB42A	4	BDQS42	T
83	PB34B	4	BDQ33	C	PB42B	4	BDQ42	C
84	PB36A	4	BDQ33	T	PB44A	4	BDQ42	T
85	PB36B	4	BDQ33	C	PB44B	4	BDQ42	C
86	VCCAUX	-			VCCAUX	-		
87	PB40A	4	BDQ42	T	PB50A	4	BDQ51	T
88	PB40B	4	BDQ42	C	PB50B	4	BDQ51	C
89	GND	-			GND	-		
90	PB42A	4	BDQS42	T	PB52A	4	BDQ51	T
91	PB42B	4	BDQ42	C	PB52B	4	BDQ51	C

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
138	PR15A	3	PCLKT3_0	T (LVDS)*	PR21A	3	PCLKT3_0/RDQ25	T (LVDS)*
139	GND	-			GND	-		
140	VCC	-			VCC	-		
141	PR13B	2	PCLKC2_0/RDQ10	C	PR19B	2	PCLKC2_0/RDQ16	C
142	PR13A	2	PCLKT2_0/RDQ10	T	PR19A	2	PCLKT2_0/RDQ16	T
143	VCCIO2	2			VCCIO2	2		
144	PR12A	2	RDQ10		PR16A	2	RDQS16	
145	GND	-			GND	-		
146	VCC	-			VCC	-		
147	PR8B	2	RDQ10	C (LVDS)*	PR14B	2	RDQ16	C (LVDS)*
148	VCCIO2	2			VCCIO2	2		
149	PR8A	2	RDQ10	T (LVDS)*	PR14A	2	RDQ16	T (LVDS)*
150	PR6B	2	RDQ10	C (LVDS)*	PR12B	2	RDQ16	C (LVDS)*
151	VCCAUX	-			VCCAUX	-		
152	PR6A	2	RDQ10	T (LVDS)*	PR12A	2	RDQ16	T (LVDS)*
153	PR4B	2		C (LVDS)*	PR6B	2	RDQ8	C (LVDS)*
154	PR4A	2		T (LVDS)*	PR6A	2	RDQ8	T (LVDS)*
155	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*
156	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*
157	PT55B	1	VREF2_1	C	PT64B	1	VREF2_1	C
158	PT55A	1	VREF1_1	T	PT64A	1	VREF1_1	T
159	GND	-			GND	-		
160	PT54B	1		C	PT62B	1		C
161	PT54A	1		T	PT62A	1		T
162	VCCIO1	1			VCCIO1	1		
163	PT52B	1		C	PT60B	1		C
164	PT52A	1		T	PT60A	1		T
165	PT50B	1		C	PT58B	1		C
166	PT50A	1		T	PT58A	1		T
167	PT48B	1		C	PT56B	1		C
168	PT48A	1		T	PT56A	1		T
169	GND	-			GND	-		
170	VCCIO1	1			VCCIO1	1		
171	VCC	-			VCC	-		
172	PT40B	1		C	PT50B	1		C
173	PT40A	1		T	PT50A	1		T
174	VCCAUX	-			VCCAUX	-		
175	GND	-			GND	-		
176	PT36B	1		C	PT44B	1		C
177	PT36A	1		T	PT44A	1		T
178	PT34B	1		C	PT42B	1		C
179	PT34A	1		T	PT42A	1		T
180	PT30B	1	PCLKC1_0	C	PT39B	1	PCLKC1_0	C
181	PT30A	1	PCLKT1_0	T	PT39A	1	PCLKT1_0	T
182	XRES	1			XRES	1		
183	PT28B	0	PCLKC0_0	C	PT37B	0	PCLKC0_0	C

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N14	CFG1	8			CFG1	8		
N13	PROGRAMN	8			PROGRAMN	8		
N15	CFG0	8			CFG0	8		
P15	PR30B	8	WRITEN	C	PR30B	8	WRITEN	C
L12	INITN	8			INITN	8		
N16	PR29B	8	CSN	C	PR29B	8	CSN	C
GND	GNDIO8	-			GNDIO8	-		
R14	CCLK	8			CCLK	8		
P14	PR30A	8	CS1N	T	PR30A	8	CS1N	T
M13	DONE	8			DONE	8		
R16	PR28B	8	D1	C	PR28B	8	D1	C
VCCIO	VCCIO8	8			VCCIO8	8		
M16	PR29A	8	D0/SPIFASTN	T	PR29A	8	D0/SPIFASTN	T
P16	PR28A	8	D2	T	PR28A	8	D2	T
L15	PR27B	8	D3	C	PR27B	8	D3	C
GND	GNDIO8	-			GNDIO8	-		
L14	PR26A	8	D6	T	PR26A	8	D6	T
L16	PR27A	8	D4	T	PR27A	8	D4	T
L10	PR25B	8	D7/SPID0	C	PR25B	8	D7/SPID0	C
L13	PR26B	8	D5	C	PR26B	8	D5	C
VCCIO	VCCIO8	8			VCCIO8	8		
K11	PR25A	8	DI/CSSPI0N	T	PR25A	8	DI/CSSPI0N	T
K14	PR24B	8	DOUT/CSON	C	PR24B	8	DOUT/CSON	C
K13	PR24A	8	BUSY/SISPI	T	PR24A	8	BUSY/SISPI	T
GND	GNDIO8	-			GNDIO8	-		
K15	PR21B	3	RLM0_GPLLC_FB_A	C	PR21B	3	RLM0_GPLLC_FB_A	C
VCCIO	VCCIO3	3			VCCIO3	3		
K16	PR21A	3	RLM0_GPLLT_FB_A	T	PR21A	3	RLM0_GPLLT_FB_A	T
GND	GNDIO3	-			GNDIO3	-		
J16	PR20B	3	RLM0_GPLLC_IN_A**	C (LVDS)*	PR20B	3	RLM0_GPLLC_IN_A**	C (LVDS)*
J15	PR20A	3	RLM0_GPLLT_IN_A**	T (LVDS)*	PR20A	3	RLM0_GPLLT_IN_A**	T (LVDS)*
J14	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
J13	PR18B	3	RLM0_GDLLC_FB_A	C	PR18B	3	RLM0_GDLLC_FB_A	C
J12	PR18A	3	RLM0_GDLLT_FB_A	T	PR18A	3	RLM0_GDLLT_FB_A	T
H12	PR17B	3	RLM0_GDLLC_IN_A**	C (LVDS)*	PR17B	3	RLM0_GDLLC_IN_A**	C (LVDS)*
GND	GNDIO3	-			GNDIO3	-		
H13	PR17A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR17A	3	RLM0_GDLLT_IN_A**	T (LVDS)*
H15	PR16B	3	VREF2_3	C	PR16B	3	VREF2_3	C
VCCIO	VCCIO3	3			VCCIO3	3		
H16	PR16A	3	VREF1_3	T	PR16A	3	VREF1_3	T
H11	PR15B	3	PCLKC3_0	C (LVDS)*	PR15B	3	PCLKC3_0	C (LVDS)*
J11	PR15A	3	PCLKT3_0	T (LVDS)*	PR15A	3	PCLKT3_0	T (LVDS)*
G16	PR13B	2	PCLKC2_0/RDQ10	C	PR13B	2	PCLKC2_0/RDQ10	C
GND	GNDIO2	-			GNDIO2	-		
G15	PR13A	2	PCLKT2_0/RDQ10	T	PR13A	2	PCLKT2_0/RDQ10	T

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U3	PL55A	6	LDQ56	T	PL74A	6	LDQ75	T
U4	PL55B	6	LDQ56	C	PL74B	6	LDQ75	C
GNDIO	GNDIO6	-			GNDIO6	-		
Y1	PL56A	6	LDQS56	T (LVDS)*	PL75A	6	LDQS75	T (LVDS)*
W1	PL56B	6	LDQ56	C (LVDS)*	PL75B	6	LDQ75	C (LVDS)*
R7	PL57A	6	LDQ56	T	PL76A	6	LDQ75	T
VCCIO	VCCIO6	6			VCCIO	6		
T7	PL57B	6	LDQ56	C	PL76B	6	LDQ75	C
V4	PL58A	6	LDQ56	T (LVDS)*	PL77A	6	LDQ75	T (LVDS)*
V3	PL58B	6	LDQ56	C (LVDS)*	PL77B	6	LDQ75	C (LVDS)*
AA2	PL59A	6	LDQ56	T	PL78A	6	LDQ75	T
GNDIO	GNDIO6	-			GNDIO6	-		
AA1	PL59B	6	LDQ56	C	PL78B	6	LDQ75	C
U7	TCK	-			TCK	-		
U5	TDI	-			TDI	-		
V5	TMS	-			TMS	-		
V6	TDO	-			TDO	-		
T8	VCCJ	-			VCCJ	-		
Y3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
Y2	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
W4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T
W3	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C
W5	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T
W6	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO	5		
AB3	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T
AB2	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C
GNDIO	GNDIO5	-			GNDIO5	-		
Y4	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T
AA3	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C
AB5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T
AB4	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C
AA5	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T
Y5	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO	5		
AB6	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T
AA6	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C
GNDIO	GNDIO5	-			GNDIO5	-		
VCCIO	VCCIO5	5			VCCIO	5		
W7	PB20A	5	BDQ24	T	PB29A	5	BDQ33	T
W8	PB20B	5	BDQ24	C	PB29B	5	BDQ33	C
Y6	PB21A	5	BDQ24	T	PB30A	5	BDQ33	T
Y7	PB21B	5	BDQ24	C	PB30B	5	BDQ33	C
AA7	PB22A	5	BDQ24	T	PB31A	5	BDQ33	T
VCCIO	VCCIO5	5			VCCIO	5		
AB7	PB22B	5	BDQ24	C	PB31B	5	BDQ33	C

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
C20	PT57B	1		C	PT66B	1		C
D20	PT57A	1		T	PT66A	1		T
A22	PT56B	1		C	PT65B	1		C
A21	PT56A	1		T	PT65A	1		T
GND	GNDIO1	-			GNDIO1	-		
E19	NC	-			NC	-		
C19	NC	-			NC	-		
VCCIO	VCCIO1	1			VCCIO1	1		
B21	NC	-			NC	-		
B20	NC	-			NC	-		
D19	NC	-			NC	-		
B19	NC	-			NC	-		
GND	GNDIO1	-			GNDIO1	-		
G17	NC	-			NC	-		
E18	NC	-			NC	-		
G19	NC	-			NC	-		
F17	NC	-			NC	-		
VCCIO	VCCIO1	1			VCCIO1	1		
A20	NC	-			NC	-		
A19	NC	-			NC	-		
E17	NC	-			NC	-		
D18	NC	-			NC	-		
B18	PT55B	1		C	PT55B	1		C
GND	GNDIO1	-			GNDIO1	-		
A18	PT55A	1		T	PT55A	1		T
E16	PT54B	1		C	PT54B	1		C
G16	PT54A	1		T	PT54A	1		T
F16	PT53B	1		C	PT53B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
H18	PT53A	1		T	PT53A	1		T
A17	PT52B	1		C	PT52B	1		C
B17	PT52A	1		T	PT52A	1		T
C18	PT51B	1		C	PT51B	1		C
B16	PT51A	1		T	PT51A	1		T
C17	PT50B	1		C	PT50B	1		C
GND	GNDIO1	-			GNDIO1	-		
D17	PT50A	1		T	PT50A	1		T
E15	PT49B	1		C	PT49B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
G15	PT49A	1		T	PT49A	1		T
A16	PT48B	1		C	PT48B	1		C
B15	PT48A	1		T	PT48A	1		T
D15	PT47B	1		C	PT47B	1		C
F15	PT47A	1		T	PT47A	1		T
A14	PT46B	1		C	PT46B	1		C
B14	PT46A	1		T	PT46A	1		T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N15	GND	-			GND	-		
N17	GND	-			GND	-		
P10	GND	-			GND	-		
P12	GND	-			GND	-		
P13	GND	-			GND	-		
P14	GND	-			GND	-		
P15	GND	-			GND	-		
P17	GND	-			GND	-		
R13	GND	-			GND	-		
R14	GND	-			GND	-		
T10	GND	-			GND	-		
T11	GND	-			GND	-		
T16	GND	-			GND	-		
T17	GND	-			GND	-		
T24	GND	-			GND	-		
T3	GND	-			GND	-		
U10	GND	-			GND	-		
U11	GND	-			GND	-		
U13	GND	-			GND	-		
U14	GND	-			GND	-		
U16	GND	-			GND	-		
U17	GND	-			GND	-		
V13	GND	-			GND	-		
V14	GND	-			GND	-		
V21	GND	-			GND	-		
V6	GND	-			GND	-		
M3	NC	-			NC	-		
N6	NC	-			NC	-		
P24	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.
***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
Y10	VCC	-		
Y11	VCC	-		
Y12	VCC	-		
Y13	VCC	-		
Y18	VCC	-		
Y19	VCC	-		
Y20	VCC	-		
J13	VCCIO0	0		
J14	VCCIO0	0		
K12	VCCIO0	0		
K13	VCCIO0	0		
K14	VCCIO0	0		
K15	VCCIO0	0		
J17	VCCIO1	1		
J18	VCCIO1	1		
J20	VCCIO1	1		
K17	VCCIO1	1		
K18	VCCIO1	1		
K20	VCCIO1	1		
L21	VCCIO2	2		
M21	VCCIO2	2		
M22	VCCIO2	2		
N21	VCCIO2	2		
N22	VCCIO2	2		
R21	VCCIO2	2		
U21	VCCIO3	3		
U22	VCCIO3	3		
V21	VCCIO3	3		
V22	VCCIO3	3		
W21	VCCIO3	3		
Y22	VCCIO3	3		
AA16	VCCIO4	4		
AA17	VCCIO4	4		
AA18	VCCIO4	4		
AA19	VCCIO4	4		
AB17	VCCIO4	4		
AB18	VCCIO4	4		
AA12	VCCIO5	5		
AA13	VCCIO5	5		
AA14	VCCIO5	5		
AB12	VCCIO5	5		
AB13	VCCIO5	5		
AB14	VCCIO5	5		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
R14	GND	-		
R15	GND	-		
R16	GND	-		
R17	GND	-		
R18	GND	-		
R19	GND	-		
R20	GND	-		
T11	GND	-		
T12	GND	-		
T13	GND	-		
T14	GND	-		
T15	GND	-		
T16	GND	-		
T17	GND	-		
T18	GND	-		
T19	GND	-		
T20	GND	-		
U11	GND	-		
U12	GND	-		
U13	GND	-		
U14	GND	-		
U15	GND	-		
U16	GND	-		
U17	GND	-		
U18	GND	-		
U19	GND	-		
U20	GND	-		
V12	GND	-		
V13	GND	-		
V14	GND	-		
V15	GND	-		
V16	GND	-		
V17	GND	-		
V18	GND	-		
V19	GND	-		
V28	GND	-		
V3	GND	-		
W12	GND	-		
W13	GND	-		
W14	GND	-		
W15	GND	-		
W16	GND	-		
W17	GND	-		

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A3	GND	-			GND	-		
A9	GND	-			GND	-		
B12	GND	-			GND	-		
B6	GND	-			GND	-		
E15	GND	-			GND	-		
E2	GND	-			GND	-		
H14	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J3	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
M15	GND	-			GND	-		
M2	GND	-			GND	-		
P9	GND	-			GND	-		
R12	GND	-			GND	-		
R5	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		
D10	NC	-			NC	-		
D11	NC	-			NC	-		
D12	NC	-			NC	-		
D13	NC	-			NC	-		
D14	NC	-			NC	-		
D4	NC	-			NC	-		
D5	NC	-			NC	-		
D6	NC	-			NC	-		
D7	NC	-			NC	-		
E11	NC	-			NC	-		
E6	NC	-			NC	-		
E8	NC	-			NC	-		
E9	NC	-			NC	-		
F10	NC	-			NC	-		
F7	NC	-			NC	-		
F8	NC	-			NC	-		
F9	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.
***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AH12	VCC	-			LLC_SQ_VCCRX1	14		
AK8	PB16A	5	BDQ15	T	LLC_SQ_HDOUTP1	14		T
AH8	NC	-			LLC_SQ_VCCOB1	14		
AJ8	PB16B	5	BDQ15	C	LLC_SQ_HDOUTN1	14		C
AH9	VCC	-			LLC_SQ_VCCTX1	14		
AJ9	PB17B	5	BDQ15	C	LLC_SQ_HDOUTN0	14		C
AK10	NC	-			LLC_SQ_VCCOB0	14		
AK9	PB17A	5	BDQ15	T	LLC_SQ_HDOUTP0	14		T
AH10	VCC	-			LLC_SQ_VCCTX0	14		
AJ12	PB19B	5	BDQ15	C	LLC_SQ_HDINN0	14		C
AJ13	NC	-			LLC_SQ_VCCIB0	14		
AK12	PB19A	5	BDQ15	T	LLC_SQ_HDINP0	14		T
AH13	VCC	-			LLC_SQ_VCCRX0	14		
AF10	PB3A	5	BDQ6	T	PB30A	5	BDQ33	T
AE8	PB3B	5	BDQ6	C	PB30B	5	BDQ33	C
AE11	PB4A	5	BDQ6	T	PB31A	5	BDQ33	T
VCCIO	VCCIO5	5			VCCIO5	5		
AD9	PB4B	5	BDQ6	C	PB31B	5	BDQ33	C
AE10	PB5A	5	BDQ6	T	PB32A	5	BDQ33	T
AD10	PB5B	5	BDQ6	C	PB32B	5	BDQ33	C
AE13	PB6A	5	BDQS6	T	PB33A	5	BDQS33	T
GNDIO	GNDIO5	-			GNDIO5	-		
AC12	PB6B	5	BDQ6	C	PB33B	5	BDQ33	C
AG2	PB7A	5	BDQ6	T	PB34A	5	BDQ33	T
AG3	PB7B	5	BDQ6	C	PB34B	5	BDQ33	C
AD13	PB8A	5	BDQ6	T	PB35A	5	BDQ33	T
VCCIO	VCCIO5	5			VCCIO5	5		
AC13	PB8B	5	BDQ6	C	PB35B	5	BDQ33	C
AE14	PB9A	5	BDQ6	T	PB36A	5	BDQ33	T
AC14	PB9B	5	BDQ6	C	PB36B	5	BDQ33	C
AF3	PB10A	5	BDQ6	T	PB37A	5	BDQ33	T
GNDIO	GNDIO5	-			GNDIO5	-		
AF4	PB10B	5	BDQ6	C	PB37B	5	BDQ33	C
VCCIO	VCCIO5	5			-	-		
AG4	PB20A	5	BDQ24	T	PB38A	5	BDQ42	T
AG5	PB20B	5	BDQ24	C	PB38B	5	BDQ42	C
GNDIO	GNDIO5	-			-	-		
VCCIO	VCCIO5	5			-	-		
AD11	PB24A	5	BDQS24****	T	PB39A	5	BDQ42	T
AF13	PB24B	5	BDQ24	C	PB39B	5	BDQ42	C
AF12	PB25A	5	BDQ24	T	PB40A	5	BDQ42	T
-	-	-			VCCIO5	5		
AD14	PB25B	5	BDQ24	C	PB40B	5	BDQ42	C
AG8	PB26A	5	BDQ24	T	PB41A	5	BDQ42	T
AF8	PB26B	5	BDQ24	C	PB41B	5	BDQ42	C
AE15	PB27A	5	BDQ24	T	PB42A	5	BDQS42****	T
-	-	-			GNDIO5	-		
VCCIO	VCCIO5	5			-	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
K19	VCCIO1	1		
F28	VCCIO2	2		
J25	VCCIO2	2		
K28	VCCIO2	2		
M21	VCCIO2	2		
M24	VCCIO2	2		
N21	VCCIO2	2		
N28	VCCIO2	2		
P21	VCCIO2	2		
R25	VCCIO2	2		
AA28	VCCIO3	3		
AB25	VCCIO3	3		
AE28	VCCIO3	3		
T25	VCCIO3	3		
U21	VCCIO3	3		
V21	VCCIO3	3		
V28	VCCIO3	3		
W21	VCCIO3	3		
W24	VCCIO3	3		
AA18	VCCIO4	4		
AA19	VCCIO4	4		
AE19	VCCIO4	4		
AF22	VCCIO4	4		
AG17	VCCIO4	4		
AG25	VCCIO4	4		
AA12	VCCIO5	5		
AA13	VCCIO5	5		
AE12	VCCIO5	5		
AF9	VCCIO5	5		
AG14	VCCIO5	5		
AG6	VCCIO5	5		
AA3	VCCIO6	6		
AB6	VCCIO6	6		
AE3	VCCIO6	6		
T6	VCCIO6	6		
U10	VCCIO6	6		
V10	VCCIO6	6		
V3	VCCIO6	6		
W10	VCCIO6	6		
W7	VCCIO6	6		
F3	VCCIO7	7		
J6	VCCIO7	7		
K3	VCCIO7	7		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AA25	PR74B	3	RDQ73	C	PR82B	3	RDQ81	C
VCCIO	VCCIO3	3			VCCIO3	3		
AC24	PR74A	3	RDQ73	T	PR82A	3	RDQ81	T
AC33	PR73B	3	RDQ73	C (LVDS)*	PR81B	3	RDQ81	C (LVDS)*
AC34	PR73A	3	RDQS73	T (LVDS)*	PR81A	3	RDQS81	T (LVDS)*
GNDIO	GNDIO3	-			GNDIO3	-		
AB24	PR72B	3	RDQ73	C	PR80B	3	RDQ81	C
Y26	PR72A	3	RDQ73	T	PR80A	3	RDQ81	T
AB33	PR71B	3	RDQ73	C (LVDS)*	PR79B	3	RDQ81	C (LVDS)*
AB34	PR71A	3	RDQ73	T (LVDS)*	PR79A	3	RDQ81	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO3	3		
Y27	PR70B	3	RDQ73	C	PR78B	3	RDQ81	C
AB29	PR70A	3	RDQ73	T	PR78A	3	RDQ81	T
AA34	PR69B	3	RDQ73	C (LVDS)*	PR77B	3	RDQ81	C (LVDS)*
AA33	PR69A	3	RDQ73	T (LVDS)*	PR77A	3	RDQ81	T (LVDS)*
AA31	PR67B	3	RDQ64	C	PR75B	3	RDQ72	C
AA32	PR67A	3	RDQ64	T	PR75A	3	RDQ72	T
GNDIO	GNDIO3	-			GNDIO3	-		
AA28	PR66B	3	RDQ64	C (LVDS)*	PR74B	3	RDQ72	C (LVDS)*
AA29	PR66A	3	RDQ64	T (LVDS)*	PR74A	3	RDQ72	T (LVDS)*
AA30	PR65B	3	RDQ64	C	PR73B	3	RDQ72	C
AB30	PR65A	3	RDQ64	T	PR73A	3	RDQ72	T
VCCIO	VCCIO3	3			VCCIO3	3		
Y28	PR64B	3	RDQ64	C (LVDS)*	PR72B	3	RDQ72	C (LVDS)*
Y29	PR64A	3	RDQS64	T (LVDS)*	PR72A	3	RDQS72	T (LVDS)*
AA24	PR63B	3	RDQ64	C	PR71B	3	RDQ72	C
GNDIO	GNDIO3	-			GNDIO3	-		
Y25	PR63A	3	RDQ64	T	PR71A	3	RDQ72	T
Y31	PR62B	3	RDQ64	C (LVDS)*	PR70B	3	RDQ72	C (LVDS)*
Y30	PR62A	3	RDQ64	T (LVDS)*	PR70A	3	RDQ72	T (LVDS)*
Y24	PR61B	3	RDQ64	C	PR69B	3	RDQ72	C
VCCIO	VCCIO3	3			VCCIO3	3		
W25	PR61A	3	RDQ64	T	PR69A	3	RDQ72	T
Y33	PR60B	3	RDQ64	C (LVDS)*	PR68B	3	RDQ72	C (LVDS)*
Y34	PR60A	3	RDQ64	T (LVDS)*	PR68A	3	RDQ72	T (LVDS)*
W28	PR58B	3	RLM3_SPLLC_FB_A/RDQ55	C	PR66B	3	RLM4_SPLLC_FB_A/RDQ63	C
GNDIO	GNDIO3	-			GNDIO3	-		
V26	PR58A	3	RLM3_SPLLT_FB_A/RDQ55	T	PR66A	3	RLM4_SPLLT_FB_A/RDQ63	T
V28	PR57B	3	RLM3_SPLLC_IN_A/RDQ55	C (LVDS)*	PR65B	3	RLM4_SPLLC_IN_A/RDQ63	C (LVDS)*
V27	PR57A	3	RLM3_SPLLT_IN_A/RDQ55	T (LVDS)*	PR65A	3	RLM4_SPLLT_IN_A/RDQ63	T (LVDS)*
V25	PR56B	3	RDQ55	C	PR64B	3	RDQ63	C
VCCIO	VCCIO3	3			VCCIO3	3		
W24	PR56A	3	RDQ55	T	PR64A	3	RDQ63	T
W33	PR55B	3	RDQ55	C (LVDS)*	PR63B	3	RDQ63	C (LVDS)*
W34	PR55A	3	RDQS55	T (LVDS)*	PR63A	3	RDQS63	T (LVDS)*
GNDIO	GNDIO3	-			GNDIO3	-		
V24	PR54B	3	RDQ55	C	PR62B	3	RDQ63	C
U26	PR54A	3	RDQ55	T	PR62A	3	RDQ63	T
W29	PR53B	3	RDQ55	C (LVDS)*	PR61B	3	RDQ63	C (LVDS)*

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
R21	VCC	-			VCC	-		
R22	VCC	-			VCC	-		
T14	VCC	-			VCC	-		
T21	VCC	-			VCC	-		
U14	VCC	-			VCC	-		
U21	VCC	-			VCC	-		
V14	VCC	-			VCC	-		
V21	VCC	-			VCC	-		
W14	VCC	-			VCC	-		
W21	VCC	-			VCC	-		
Y13	VCC	-			VCC	-		
Y14	VCC	-			VCC	-		
Y21	VCC	-			VCC	-		
Y22	VCC	-			VCC	-		
C12	VCCIO0	0			VCCIO0	0		
C16	VCCIO0	0			VCCIO0	0		
E14	VCCIO0	0			VCCIO0	0		
H12	VCCIO0	0			VCCIO0	0		
H16	VCCIO0	0			VCCIO0	0		
M14	VCCIO0	0			VCCIO0	0		
M15	VCCIO0	0			VCCIO0	0		
C19	VCCIO1	1			VCCIO1	1		
C23	VCCIO1	1			VCCIO1	1		
E21	VCCIO1	1			VCCIO1	1		
H19	VCCIO1	1			VCCIO1	1		
H23	VCCIO1	1			VCCIO1	1		
M20	VCCIO1	1			VCCIO1	1		
M21	VCCIO1	1			VCCIO1	1		
G32	VCCIO2	2			VCCIO2	2		
K28	VCCIO2	2			VCCIO2	2		
K32	VCCIO2	2			VCCIO2	2		
N27	VCCIO2	2			VCCIO2	2		
N32	VCCIO2	2			VCCIO2	2		
P23	VCCIO2	2			VCCIO2	2		
R23	VCCIO2	2			VCCIO2	2		
T27	VCCIO2	2			VCCIO2	2		
T32	VCCIO2	2			VCCIO2	2		
AA23	VCCIO3	3			VCCIO3	3		
AB27	VCCIO3	3			VCCIO3	3		
AB32	VCCIO3	3			VCCIO3	3		
AE28	VCCIO3	3			VCCIO3	3		
AE32	VCCIO3	3			VCCIO3	3		
AH32	VCCIO3	3			VCCIO3	3		
W27	VCCIO3	3			VCCIO3	3		
W32	VCCIO3	3			VCCIO3	3		
Y23	VCCIO3	3			VCCIO3	3		
AC20	VCCIO4	4			VCCIO4	4		
AC21	VCCIO4	4			VCCIO4	4		
AG19	VCCIO4	4			VCCIO4	4		